

	Type	L #	Hits	Search Text	DBs	Time Stamp	Com ment s	Er ro r m e s s a g e	Er ro r s
1	BRS	L1	712	((self adj align) and semiconductor) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:09			0
2	BRS	L8	712	1 and @pd<=199800927	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:12			0
3	BRS	L15	22	"4222164"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:01			0
4	IS&R	L22	30	((("4222164") or ("4232361") or ("3574010") or ("3609477") or ("3756924") or ("3763408") or ("3855690") or ("3906541") or ("3909925") or ("4029522"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:29			0
5	IS&R	L29	2	("5,907,771").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:55			0
6	IS&R	L36	0	("((undoped adj (silicate glass)) near5 (mask or "hard mask")) and (doped adj (oxide or "silicon dioxide" or SiO2))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:59			0
7	IS&R	L43	0	("((undoped adj (silicate glass)) near5 (mask or "hard mask"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:58			0
8	IS&R	L50	0	("((undoped adj ("silicate glass" or oxide)) near5 (mask or "hard mask"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 11:59			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Com ment s	Er ro r in fo r m a t i o n	Er ro rs
9	BRS	L57	2	((undoped adj (silicate glass)) near5 (mask or "hard mask")) and (doped adj (oxide or "silicon dioxide" or SiO2))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:05			0
10	BRS	L64	7	((undoped adj ("silicate glass" or SiO2 or "silicon dioxide")) near5 (mask or "hard mask")) and (doped adj (oxide or "silicon dioxide" or SiO2))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:07			0
11	BRS	L71	392294	etch\$3 ((undoped and doped) adj2 ("silicate glass" or SiO2 or "silicon dioxide"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:13			0
12	BRS	L78	66986	71 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:12			0
13	BRS	L85	36927	71 and ("contact hole" or SAC or (self adj align\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:14			0
14	BRS	L92	15920	85 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:14			0
15	BRS	L99	15920	92 and @pd<=199800927	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:14			0
16	BRS	L106	231	etch\$3 and ((undoped and doped) adj2 ("silicate glass" or SiO2 or "silicon dioxide"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:45			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Com ments	Er rors
17	BRS	L113	86	106 and ("contact hole" or SAC or (self adj align\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:14		0
18	BRS	L120	86	113 and @pd<=199800927	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:03		0
19	BRS	L127	66	120 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:03		0
20	BRS	L134	185	etch\$3 and ((doped) adj2 ("silicate glass" or SiO2 or "silicon dioxide") same (mask or "hard mask"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 12:56		0
21	BRS	L141	129451	134and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:03		0
22	BRS	L148	112	134 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:31		0
23	BRS	L155	112	148 and @pd<=199800927	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:30		0
24	BRS	L162	0	("undoped" adj2 ("silicon oxide" or glass)) near5 ("over doped" adj2 ("silicon dioxide" or glass))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:17		0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Com men ts	Er ro rs
25	BRS	L169	0	("undoped" adj2 ("silicon oxide" or glass)) near10 ("over doped" adj2 ("silicon dioxide" or glass))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:19		0
26	BRS	L176	142	((form\$3 or deposit\$3 or etch\$3) same(("undoped" and doped) adj ("silicon oxide" or glass))) and (contact hole or SAC or (self adj align\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:26		0
27	BRS	L183	142	176 and @pd<=199800927	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:30		0
28	BRS	L190	107	183 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/04 13:31		0